502736721 03/25/2014 PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | | NEW ASSIGNMENT | | |
|---|-----------|------------------------------------|----------------|--|
| NATURE OF CONVEYANCE: | | ASSIGNMENT | | |
| CONVEYING PARTY | / DATA | | | |
| Name | | Name | Execution Date | |
| HOOMAN SHIRANI- | MEHR | | 01/14/2014 | |
| QINGHUA LI | | | 03/07/2014 | |
| YUAN ZHU | | | 01/20/2014 | |
| City: State/Country: Postal Code: | CALIF | SANTA CLARA CALIFORNIA 95054 | | |
| | RS Total: | 1 | | |
| Property Type | | Number | | |
| | : | | | |

| T HOHE. | 012-070-0000 |
|---------------------|--------------------------------------|
| Email: | request@slwip.com |
| Correspondent Name: | SCHWEGMAN, LUNDBERG & WOESSNER/INTEL |
| Address Line 1: | PO BOX 2938 |
| Address Line 4: | MINNEAPOLIS, MINNESOTA 55402 |

| ATTORNEY DOCKET NUMBER: | 884.Q15US1 | | | |
|-------------------------|-----------------|--|--|--|
| NAME OF SUBMITTER: | NANCY CUNDALL | | | |
| SIGNATURE: | /Nancy Cundall/ | | | |
| DATE SIGNED: | 03/25/2014 | | | |
| Total Attachments: 7 | | | | |

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Atty Ref/Docket No.: 884.Q15US1

Patent and Trademark Office

| To the Director of the U.S. Patent and Trademark Office: Plea | ase record the attached original documents or copy thereof. | | | |
|--|---|--|--|--|
| 1. Name of conveying party(ies): | 2. Name and address of receiving party(ies): | | | |
| Hooman Shirani-Mehr, Qinghua Li, Yuan Zhu | Name: Intel Corporation | | | |
| | Street Address: 2200 Mission College Blvd. City: <u>Santa Clara</u> State: <u>CA</u> Zip: <u>95054</u> Country: <u>United States of America</u> | | | |
| Additional name(s) of conveying party(ies) attached? []Yes [X]No | | | | |
| 3. Nature of conveyance: | Additional name(s) & address(es) attached? []Yes [X]No | | | |
| [X] Assignment [] Merger [] Security Agreement [] Change of Name [] Other | | | | |
| Execution Date: January 14, 2014, March 7, 2014, January 20, 2014 | | | | |
| 4. Application number(s) or patent number(s): | | | | |
| If this document is being filed together with a new application | n, the execution date of the application is: | | | |
| A. Patent Application No.(s) | B. Patent No.(s) | | | |
| Serial No. 14/141,206 | | | | |
| Additional numbers attached? []Yes [X]No | | | | |
| 5. Nous and address of marty to whom company and area | 6. Total number of applications and patents involved: 1 | | | |
| 5. Name and address of party to whom correspondence concerning document should be mailed: | 7. Total fee (37 CFR 3.41):\$ 0.00 | | | |
| Name: Justin R. McCarthy | []Enclosed | | | |
| Address: | Authorized to be charged to deposit account 19- | | | |
| Schwegman, Lundberg & Woessner, P.A. P.O. Box 2938 | 0743 | | | |
| Minneapolis, MN 554020938 | Please charge any additional fees or credit any over payments to our Deposit Account No.: 19-0743 | | | |
| DO NOT USE THIS SPACE | | | | |
| 9. Statement and signature. To the best of my knowledge and belief, the foregoing inform of the original document. Justin R. McCarthy/Reg. No. 67,101 | nation is true and correct and any attached copy is a true copy $3/24/2014$ | | | |
| Name of Person Signing | Signature Date | | | |
| ✓ Tota | al number of pages including cover sheet: 7 | | | |

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks Mail Stop Assignment Recordation Services P.O. Box 1450 Alexandria, VA 22313-1450

<u>ASSIGNMENT</u>

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Hooman Shirani-Mehr, Qinghua Li, Yuan Zhu

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SUBSPACE TRACKING IN FULL DIMENSION MIMO

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on December 26, 2013 as

United States of America Application Number 14/141,206

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignce may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and

Page 1 of 2

Intel Docket No.: P62954 SLW Reference No.: 884.Q15US1

the history thereof; and generally assist said Assignce, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignce, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

homan_ <u> Arehr</u>

Hooman Shirani-Mehr

<u>01 - 14 - 2014</u> Date Signed

Qinghua Li

Date Signed

Yuan Zhu

Date Signed

Page 2 of 2

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Hooman Shirani-Mehr

é ce CF Qinghua I

Yuan Zhu

Date Signed

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Date Signed

Date Signed

Page 2 of 2

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Hooman Shirani-Mehr

Date Signed

Qinghua Li

Yuan Zhu

Date Signed

7.014-1-2.0 Date Signed